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CLAIMS

What is claimed is:

1. A circuit apparatus, comprising:

a laminar support;

a conductive track on the laminar support;

an auxiliary conductive element electrically connected to the conductive track, wherein the auxiliary conductive element is applied by means of an apparatus for applying SMD components.

- 2. The apparatus of claim 1, wherein the auxiliary conductive element is electrically connected to the laminar support by means of an adhesive and soldered thereto by a wave soldering procedure.
- 3. The apparatus of claim 1, wherein the auxiliary conductive element is electrically connected to the laminar support by means of a cream solder and a reflow soldering procedure.
 - 4. The apparatus of claim 1, wherein said laminar support includes a first face a second face, and a thickness, the first face exhibits a plurality of auxiliary conductive elements and a plurality of SMD electronic components, the second face

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exhibits a plurality of electronic components furnished with legs, and the legs pass through the thickness of the laminar support.

- 5. The apparatus of claim 4, wherein the auxiliary conductive elements are mutually identical.
 - 6. The apparatus of claim 1, wherein the auxiliary conductive element includes a metal pad.
 - 7. The apparatus of claim 1, wherein

the auxiliary conductive element is electrically connected to the conductive track by a solder alloy; and

the auxiliary conductive element includes a metal with high electrical conductivity, and

the auxiliary conductive element is coated with a metallic layer with both high wettability and a melting temperature higher than the melting temperature of the solder alloy.

- 8. A flexible material strip, comprising:
- 20 a plurality of auxiliary conductive elements; and



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a plurality of adjacent recesses, wherein each of the recesses houses a respective auxiliary conductive element.

- 9. The flexible material strip of claim 8, wherein the auxiliary conductive selement includes a metal pad.
 - 10. The flexible material strip of claim 8, wherein each auxiliary conductive element is produced from a metal with high electrical conductivity and coated with a metallic layer with both a wettability and a melting temperature sufficient for a soldering process.